January 2001



Si4466DY

Single N-Channel 2.5V Specified PowerTrench® MOSFET

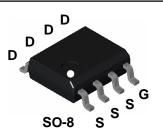
General Description

This N-Channel 2.5V specified MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

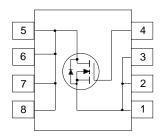
Applications

- DC/DC converter
- Load switch
- Battery protection



Features

- 15 A, 20 V. $R_{DS(on)} = 0.0075 \ \Omega \ @ V_{GS} = 4.5 \ V$ $R_{DS(on)} = 0.010 \ \Omega \ @ V_{GS} = 2.5 \ V.$
- Low gate charge (47nC typical).
- Fast switching speed.
- High performance trench technology for extremely low R_{DS(ON)}.
- High power and current handling capability.



Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter Drain-Source Voltage		Ratings	Units V	
V _{DSS}			20		
V _{GSS}	Gate-Source Voltage		<u>+</u> 12	V	
ID	Drain Current - Continuous	(Note 1a)	15	А	
	- Pulsed		50		
P _D	Power Dissipation for Single Operation	(Note 1a)	2.5	W	
		(Note 1b)	1.2		
		(Note 1c)	1		
T _J , T _{stg}	Operating and Storage Junction Temperature Range		-55 to +150	°C	

Thermal Characteristics

R _{θJA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
R _θ յc	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

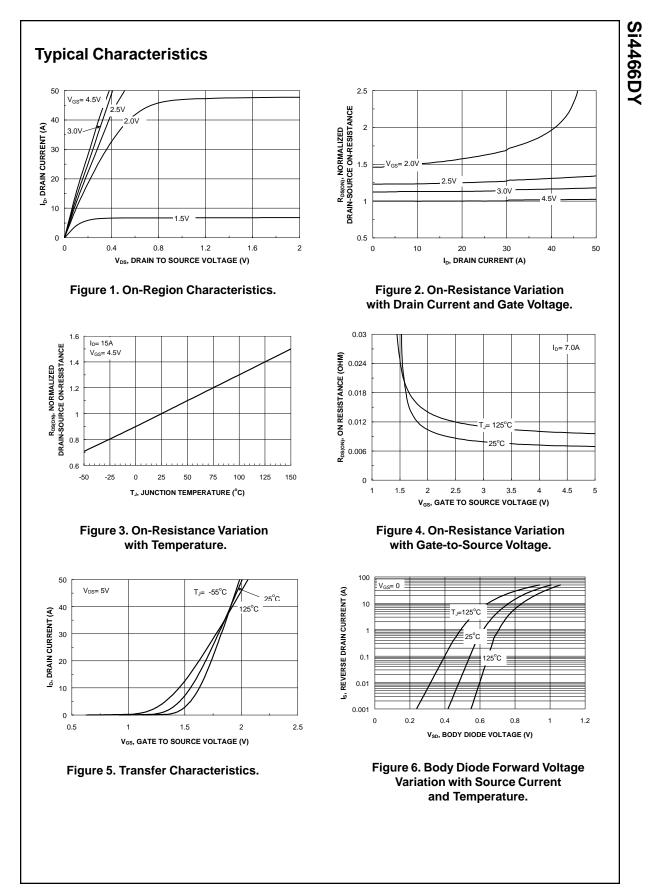
Package Outlines and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
4466	Si4466DY	13"	12mm	2500 units

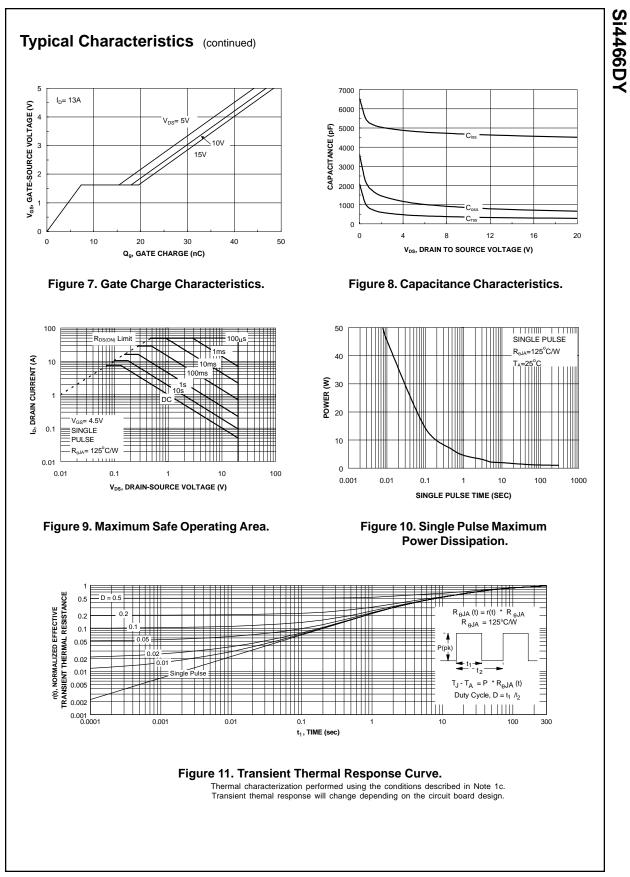
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	Parameter	Test Conditions	Min	Тур	Мах	Units
Off Char	racteristics					
SV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$	20			V
<u>BV_{DSS}</u> ΔTJ	Breakdown Voltage Temperature Coefficient	$I_D = 250\mu$ A, Referenced to 25° C		29		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 16 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μA
SSF	Gate-Body Leakage, Forward	$V_{GS} = 12 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA
SSR	Gate–Body Leakage, Reverse	$V_{GS} = -12 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			-100	nA
n Char	acteristics (Note 2)	•				
GS(th)	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	0.4	0.9	1.5	V
$\Delta V_{GS(th)}$ ΔT_J	Gate Threshold Voltage Temperature Coefficient	$I_D = 250\mu$ A, Referenced to 25°C		-4		mV/°C
RDS(on)	Static Drain-Source On-Resistance			0.006 0.009 0.008	0.0075 0.0130 0.0100	Ω
D(on)	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5.0 \text{ V}$	25			Α
FS	Forward Transconductance	$V_{DS} = 5 V, I_D = 15 A$		70		S
Dynamio	c Characteristics				-	
iss	Input Capacitance	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		4700		pF
oss	Output Capacitance	f = 1.0 MHz		850		pF
rss	Reverse Transfer Capacitance			310		pF
Switchir	a Characteristics				<u>.</u>	
d(on)	ng Characteristics (Note 2) Turn-On Delay Time	V _{DD} = 10 V, I _D = 1 A,		20	32	ns
1(011)	Turn-On Rise Time	$V_{GS} = 4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		27	44	ns
l(off)	Turn-Off Delay Time	-		95	133	ns
((()))	Turn-Off Fall Time	-		35	56	ns
) _g	Total Gate Charge	V _{DS} = 10 V, I _D = 15 A,		47	66	nC
lgs	Gate-Source Charge	$V_{GS} = 5 V,$		7		nC
2 _{aq}	Gate-Drain Charge	-		10.5		nC
5						
	Durce Diode Characteristics ar Maximum Continuous Drain-So				2.1	A
	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = 2.1 A$ (Note 2)		0.65	1.2	N V
s V _{SD}						v

2. Pulse Test: Pulse Width $\leq 300~\mu s,$ Duty Cycle $\leq 2.0\%$



Si4466DY Rev. A



Si4466DY Rev. A

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